



Attorney's Docket No.: 12816-021001 / S1166 SB/flu

AF/2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Detlef Weber

Art Unit : 2814

Serial No. : 09/898,909

Examiner : P. Cao

Filed : July 3, 2001

Title : METALLIZATION ARRANGEMENT FOR SEMICONDUCTOR STRUCTURE
AND CORRESPONDING FABRICATION METHOD

MAIL STOP AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

AMENDMENT IN REPLY TO ACTION OF JULY 9, 2003

Please amend the above-identified application as follows:

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TECHNOLOGY CENTER 2800

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 9, 2003

Date of Deposit

Signature

Stefanie Dion

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